### T-1 (3mm) SOLID STATE LAMP

PRELIMINARY SPEC

Part Number: WP7104VGC/Z

**GREEN** 



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

### **Features**

- LOW POWER CONSUMPTION.
- POPULAR T-1 DIAMETER PACKAGE.
- GENERAL PURPOSE LEADS.
- RELIABLE AND RUGGED.
- LONG LIFE SOLID STATE RELIABILITY.
- AVAILABLE ON TAPE AND REEL.
- RoHS COMPLIANT.

## Description

The Green source color devices are made with InGaN Light Emitting Diode.

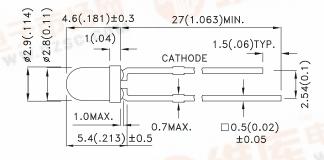
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

## **Package Dimensions**





### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3 Lead spacing is measured where the leads emerge from the package.

Specifications are subject to change without notice.





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## **Selection Guide**

Part No.	Part No. Dice Lens Type		lv (mcd) [2] @ 20mA		Viewing Angle [1]
		7,1	Min.	Тур.	201/2
WP7104VGC/Z	GREEN (InGaN)	WATER CLEAR	3300	9000	34°

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
- 2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	525		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	535		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	39		nm	IF=20mA
С	Capacitance	Green	65		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	3.7	V	IF=20mA
lR	Reverse Current	Green		10	uA	VR = 5V

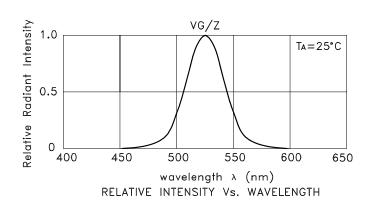
- Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

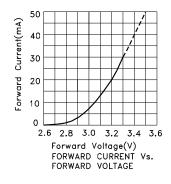
Units			
mW			
mA			
mA			
V			
<u> </u>			
260°C For 3 Seconds			
260°C For 5 Seconds			

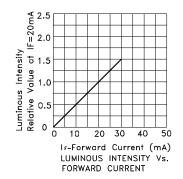
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
  2. 2mm below package base.
  3. 5mm below package base.

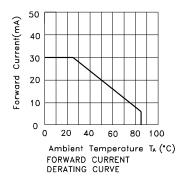
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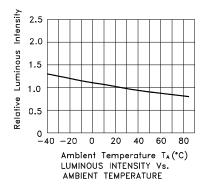


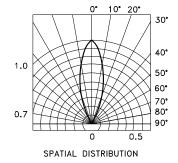
Green WP7104VGC/Z



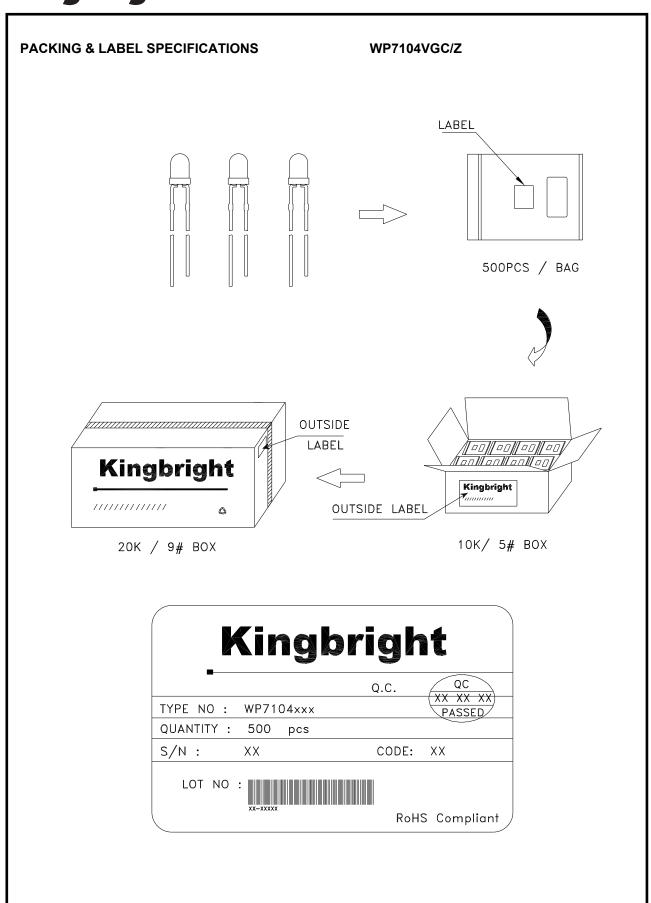








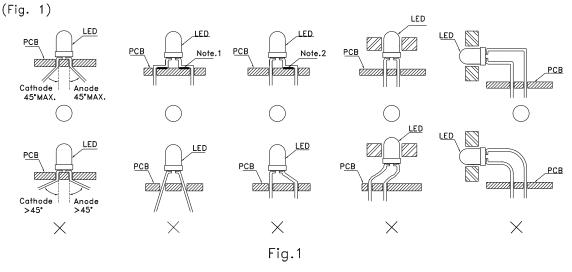
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## LED MOUNTING METHOD

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.



" $\bigcirc$ " Correct mounting method " $\times$ " Incorrect mounting method Note 1-2: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig. 2)

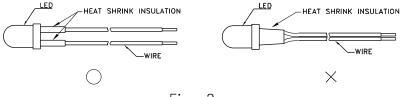
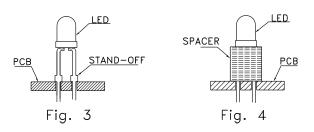


Fig. 2

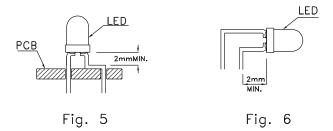
3. Use stand—offs (Fig. 3) or spacers (Fig. 4) to securely position the LED above the PCB.



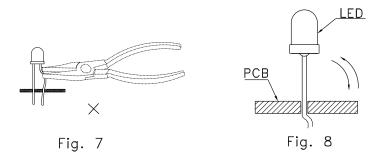
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## LEAD FORMING PROCEDURES

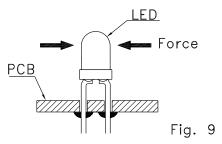
1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)



- 2. Lead forming or bending must be performed before soldering, never during or after Soldering.
- 3. Do not stress the LED lens during lead—forming in order to fractures in the lens epoxy and damage the internal structures.
- 4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)
- 5. Do not bend the leads more than twice. (Fig. 8)



6. After soldering or other high—temperature assembly, allow the LED to cool down to 50°C before applying outside force (Fig. 9). In general, avoid placing excess force on the LED to avoid damage. For any questions please consult with Kingbright representative for proper handling procedures.



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